

Technical Note

ROHM's Selection Operational Amplifier/Comparator Series



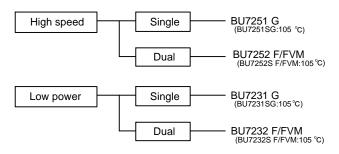
Comparators: Low Voltage CMOS

BU7251G,BU7251SG,BU7231G,BU7231SG, BU7252F/FVM,BU7252S F/FVM,BU7232F/FVM,BU7232S F/FVM

No.09049EAT06

Description

CMOS comparator BU7251/BU7231family and BU7252/BU7232 family are input full swing and push pull output comparator. These ICs integrate one op-amp or two independent op-amps and phase compensation capacitor on a single chip. The features of these ICs are low operating supplyVoltage that is +1.8V to +5.5V(single supply) and low supply current, extremely low input bias current.

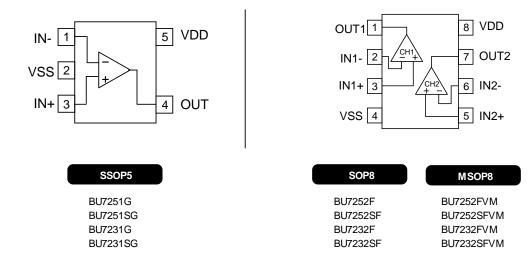


Features

- 1) Low operating supply voltage (+1.8[V]~+5.5[V])
- 2) +1.8 [V]~+5.5[V](single supply) ±0.9[V]~±2.75[V](split supply)
- 3) Input and Output full swing
- 4) Push-pull output type
- 5) High speed operation
- (BU7251 family, BU7252 family)
- 6) Low supply current (BU7231 family, BU7232 family)
- Internal ESD protection Human body model (HBM) ±4000[V](Typ.)
- 8) Wide temperature range -40[°C]~+85[°C] -40[°C]~+105[°C]

(BU7251G,BU7252 family, BU7231G, BU7232 family) (BU7251SG,BU7252S family, BU7231SG,BU7232S family)

Pin Assignments



●Absolute maximum ratings (Ta=25[°C])

		Rating					
Parameter	Symbol	BU7251G,BU7252 F/FVM	BU7251SG,BU7252S F/FVM	Unit			
		BU7231G,BU7232 F/FVM	BU7231SG,BU7232S F/FVM				
Supply Voltage	VDD-VSS	+7					
Differential Input Voltage (*1)	Vid	VDD-VSS					
Input Common-mode voltage range	Vicm	(VSS-0.3) to VDD+0.3					
Operating Temperature	Topr	-40 to+85	-40 to+105	°C			
Storage Temperature	Tstg	-55 to+125					
Maximum junction Temperature	Tjmax	+125					

Note Absolute maximum rating item indicates the condition which must not be exceeded.

Application of voltage in excess of absolute maximum rating or use out absoluted maximum rated temperature environment may cause deterioration of characteristics. The voltage difference between inverting input and non-inverting input is the differential input voltage. Then input terminal voltage is set to more then VEE. (*1)

Electrical characteristics

OBU7251 family (Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[°C])

	Tomporatura	Gua	ranteed L	_imit			
Symbol		BU725	51G,BU72	251SG	Unit	Condition	
	Tange	Min.	Тур.	Max.			
Vio	25°C	-	1	11	mV	-	
lio	25°C	-	1	-	pА	-	
lb	25°C	-	1	-	pА	-	
Vicm	25°C	0	-	3	V	(VDD-VSS)=3[V]	
AV	25°C	-	90	-	dB	RL=10[kΩ]	
IDD	25°C	-	15	35		RL=∞	
	full range	-	-	50	μΑ		
PSRR	25°C	-	80	-	dB	-	
CMRR	25°C	-	80	-	dB	-	
IOH	25°C	1	2	-	mΑ	VDD-0.4	
IOL	25°C	3	6	-	mΑ	VSS+0.4	
VOH	25°C	VDD-0.1	-	-	V	RL=10[kΩ]	
VOL	25°C	-	-	VSS+0.1	V	RL=10[kΩ]	
Tr	25°C	-	50	-	ns	CL=15pF 100mV over drive	
Tf	25°C	-	20	-	ns	CL=15pF 100mV over drive	
TPLH	25°C	-	0.55	-	μs	CL=15pF 100mV over drive	
TPHL	25°C	-	0.25	-	μs	CL=15pF 100mV over drive	
	Vio lio Ib Vicm AV IDD PSRR CMRR IOH IOL VOH VOL Tr Tf TfLH	Symbol range Vio 25°C lio 25°C lb 25°C Vicm 25°C AV 25°C IDD 25°C IDD 25°C Gull range PSRR PSRR 25°C IOH 25°C IOH 25°C VOH 25°C VOH 25°C Tr 25°C Tf 25°C TPLH 25°C	$\begin{tabular}{ c c c } \hline \mbox{Hemperature} \\ \hline range & BU725 \\ \hline \mbox{Min.} \\ \hline Mi$	$\begin{tabular}{ c c c c } \hline & & & & & & & & & & & & & & & & & & $	$\begin{tabular}{ c c c c } \hline & & & & & & & & & & & & & & & & & & $	$ \begin{array}{ c c c c } \hline \mbox{Imperature} & \hline \mbox{BU7251G,BU7251SG} & \mbox{Imperature} \\ \hline \mbox{Min.} & \mbox{Typ.} & \mbox{Max.} \\ \hline \mbox{Min} & \mbox{Typ.} & \mbox{Max.} \\ \hline \mbox{Vio} & 25^{\circ}\mbox{C} & - & 1 & 11 & \mbox{mV} \\ \hline \mbox{Ib} & 25^{\circ}\mbox{C} & - & 1 & - & \mbox{pA} \\ \hline \mbox{Ib} & 25^{\circ}\mbox{C} & - & 1 & - & \mbox{pA} \\ \hline \mbox{Ib} & 25^{\circ}\mbox{C} & - & 1 & - & \mbox{pA} \\ \hline \mbox{Vicm} & 25^{\circ}\mbox{C} & 0 & - & 3 & \mbox{V} \\ \hline \mbox{AV} & 25^{\circ}\mbox{C} & - & \mbox{90} & - & \mbox{dB} \\ \hline \mbox{IDD} & \frac{25^{\circ}\mbox{C}}{full range} & - & - & \mbox{50} & \\ \hline \mbox{PSRR} & 25^{\circ}\mbox{C} & - & \mbox{80} & - & \mbox{dB} \\ \hline \mbox{PSRR} & 25^{\circ}\mbox{C} & - & \mbox{80} & - & \mbox{dB} \\ \hline \mbox{IOH} & 25^{\circ}\mbox{C} & 1 & 2 & - & \mbox{mA} \\ \hline \mbox{IOH} & 25^{\circ}\mbox{C} & 1 & 2 & - & \mbox{mA} \\ \hline \mbox{IOL} & 25^{\circ}\mbox{C} & 3 & \mbox{6} & - & \mbox{mA} \\ \hline \mbox{VOH} & 25^{\circ}\mbox{C} & - & \mbox{50} & - & \mbox{VS+0.1} & \mbox{V} \\ \hline \mbox{VOL} & 25^{\circ}\mbox{C} & - & \mbox{50} & - & \mbox{mS} \\ \hline \mbox{Tr} & 25^{\circ}\mbox{C} & - & \mbox{50} & - & \mbox{ms} \\ \hline \mbox{TPLH} & 25^{\circ}\mbox{C} & - & \mbox{0.55} & - & \mbox{µs} \\ \hline \end{tabular}$	

Abusolute values (*2) (*3)

Reference to power dissipation under the high temperature environment and decide the output current.

(*4)

OBU7252 family (Unless otherwise specified VDD=+3[V] VSS=0[V] Ta=25[°C])

OBU7252 family (Unless otherwise	specified	vDD=+3[v],	v33=0[v], ia=zo[
Parameter	Symbol	Temperature range	Guaranteed Limit BU7252 F/FVM BU7252S F/FVM			Unit	Condition
		· ····g·	Min.	Тур.	Max.		
Input Offset Voltage (*2)(*4)	Vio	25°C	-	1	11	mV	-
Input Offset Current (*2)	lio	25°C	-	1	-	pА	-
Input Bias Current (*2)	lb	25°C	-	1	-	pА	-
Input Common-mode voltage Range	Vicm	25°C	0	-	3	V	(VDD-VSS)=3[V]
Large Signal Voltage Gain	AV	25°C	-	90	-	dB	RL=10[kΩ]
Supply current ^(*4)	IDD	25°C	-	35	65	μA	RL=∞
		full range	-	-	80	μA	
Power supply rejection ratio	PSRR	25°C	-	80	-	dB	-
Common-mode rejection ratio	CMRR	25°C	-	80	-	dB	-
Output source current (*3)	IOH	25°C	1	2	-	mΑ	VDD-0.4
Output sink current (*3)	IOL	25°C	3	6	-	mA	VSS+0.4
High Level Output Voltage (*4)	VOH	25°C	VDD-0.1	-	-	V	RL=10[kΩ]
Low Level Output Voltage (*4)	VOL	25°C	-	-	VSS+0.1	V	RL=10[kΩ]
Output rise time	Tr	25°C	-	50	-	ns	CL=15pF 100mV over drive
Output fall time	Tf	25°C	-	20	-	ns	CL=15pF 100mV over drive
Propagation delay L to H	TPLH	25°C	-	0.55	-	μs	CL=15pF 100mV over drive
Propagation delay H to L	TPHL	25°C	-	0.25	-	μs	CL=15pF 100mV over drive

Abusolute values (*2)

Reference to power dissipation under the high temperature environment and decide the output current. Continuous short circuit is occurring the degenerate of output current characteristics. Full range BU7251,BU7252 : Ta=-40[°C] to +85[°C] BU7251S,BU7252S : Ta=-40[°C] to +105[°C] (*3)

(*4)

OBU7231 family (Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[°C])

OBU7231 family (Unless otherwise	specifieu	vDD=+3[v],	v33=0[v], ia=z5[
		Temperature range	Gua	ranteed L	_imit	Unit		
Parameter	Symbol		BU723	31G,BU72	231SG		Condition	
		lange	Min.	Тур.	Max.			
Input Offset Voltage (*5)	Vio	25°C	-	1	11	mV	-	
Input Offset Current (*5)	lio	25°C	-	1	-	pА	-	
Input Bias Current (*5)	lb	25°C	-	1	-	pА	-	
Input Common-mode voltage Range	Vicm	25°C	0	-	3	V	(VDD-VSS)=3[V]	
Large Signal Voltage Gain	AV	25°C	-	90	-	dB	RL=10[kΩ]	
	IDD	25°C	-	5	15		RL=∞	
Supply current		full range	-	-	30	μA	RL=~	
Power supply rejection ratio	PSRR	25°C	-	80	-	dB	-	
Common-mode rejection ratio	CMRR	25°C	-	80	-	dB	-	
Output source current (*6)	IOH	25°C	1	2	-	mA	VDD-0.4	
Output sink current (*6)	IOL	25°C	3	6	-	mA	VSS+0.4	
High Level Output Voltage (*7)	VOH	25°C	VDD-0.1	-	-	V	RL=10[kΩ]	
Low Level Output Voltage (*7)	VOL	25°C	-	-	VSS+0.1	V	RL=10[kΩ]	
Output rise time	Tr	25°C	-	50	-	ns	CL=15pF 100mV over drive	
Output fall time	Tf	25°C	-	20	-	ns	CL=15pF 100mV over drive	
Propagation delay L to H	TPLH	25°C	-	1.7	-	μs	CL=15pF 100mV over drive	
Propagation delay H to L	TPHL	25°C	-	0.5	-	mV	CL=15pF 100mV over drive	
(*E) A hugaluta valuea			-					

(*5) Abusolute values

Reference to power dissipation under the high temperature environment and decide the output current. (*6)

Continuous short circuit is occurring the degenerate of output current characteristics.

(*7) Full range BU7231 : Ta=-40[°C] to +85[°C] BU7231S,BU7232S : Ta=-40[°C] to +105[°C]

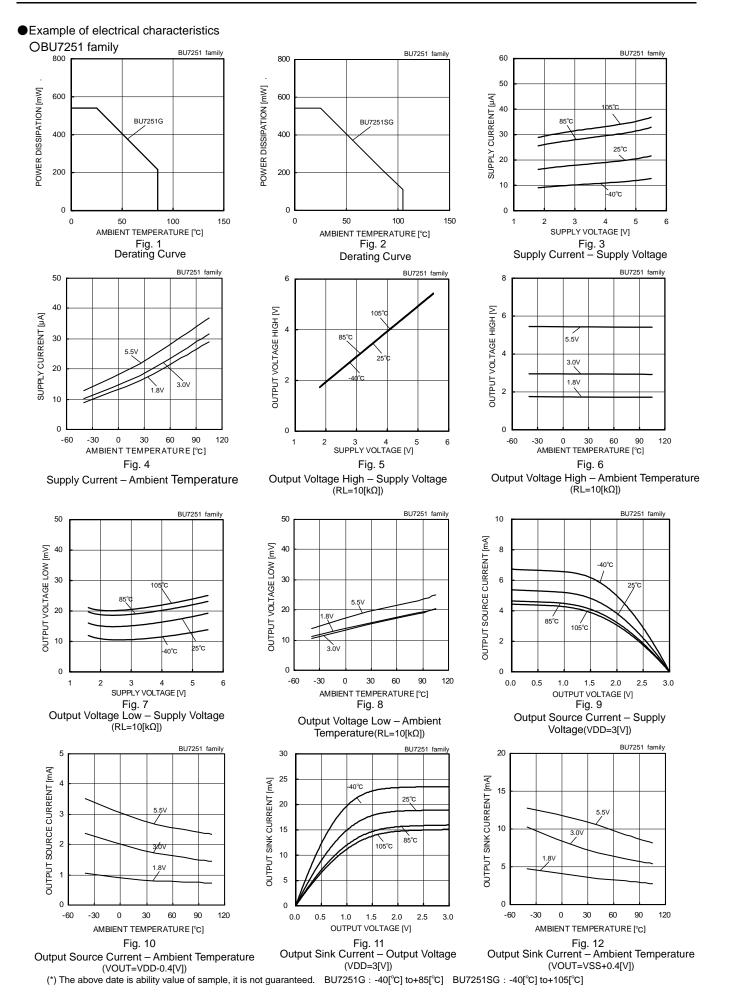
OBU7232 family (Unless otherwise specified VDD=+3[V], VSS=0[V], Ta=25[°C])

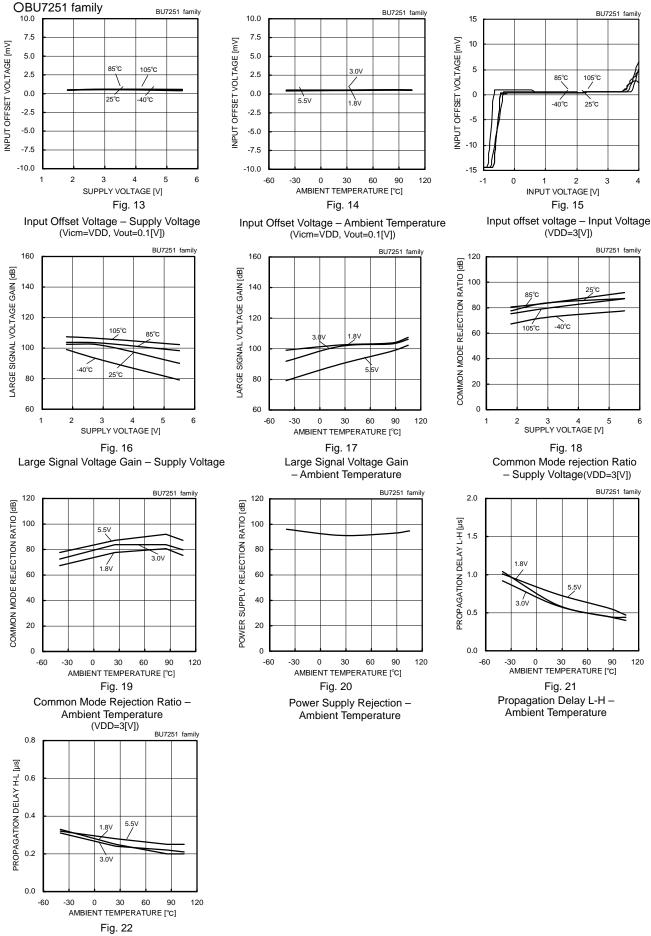
Parameter	Symbol	Temperature range	Guaranteed Limit BU7232F/FVM BU7232S F/FVM			Unit	Condition
		0	Min.	Тур.	Max.		
Input Offset Voltage (*5)	Vio	25°C	-	1	11	mV	-
Input Offset Current (*5)	lio	25°C	-	1	-	pА	-
Input Bias Current (*5)	lb	25°C	-	1	-	pА	-
Input Common-mode voltage Range	Vicm	25°C	0	-	3	V	(VDD-VSS)=3[V]
Large Signal Voltage Gain	AV	25°C	-	90	-	dB	RL=10[kΩ]
Supply surront	IDD	25°C	-	10	25	μA	RL=∞
Supply current	שטו	full range	-	-	50	μΑ	KL=~
Power supply rejection ratio	PSRR	25°C	-	80	-	dB	-
Common-mode rejection ratio	CMRR	25°C	-	80	-	dB	-
Output source current (*6)	IOH	25°C	1	2	-	mA	VDD-0.4
Output sink current (*6)	IOL	25°C	3	6	-	mA	VSS+0.4
High Level Output Voltage (*7)	VOH	25°C	VDD-0.1	-	-	V	RL=10[kΩ]
Low Level Output Voltage (*7)	VOL	25°C	-	-	VSS+0.1	V	RL=10[kΩ]
Output rise time	Tr	25°C	-	50	-	ns	CL=15pF 100mV over drive
Output fall time	Tf	25°C	-	20	-	ns	CL=15pF 100mV over drive
Propagation delay L to H	TPLH	25°C	-	1.7	-	μs	CL=15pF 100mV over drive
Propagation delay H to L	TPHL	25°C	-	0.5	-	mV	CL=15pF 100mV over drive

(*5) Abusolute values

Reference to power dissipation under the high temperature environment and decide the output current. (*6)

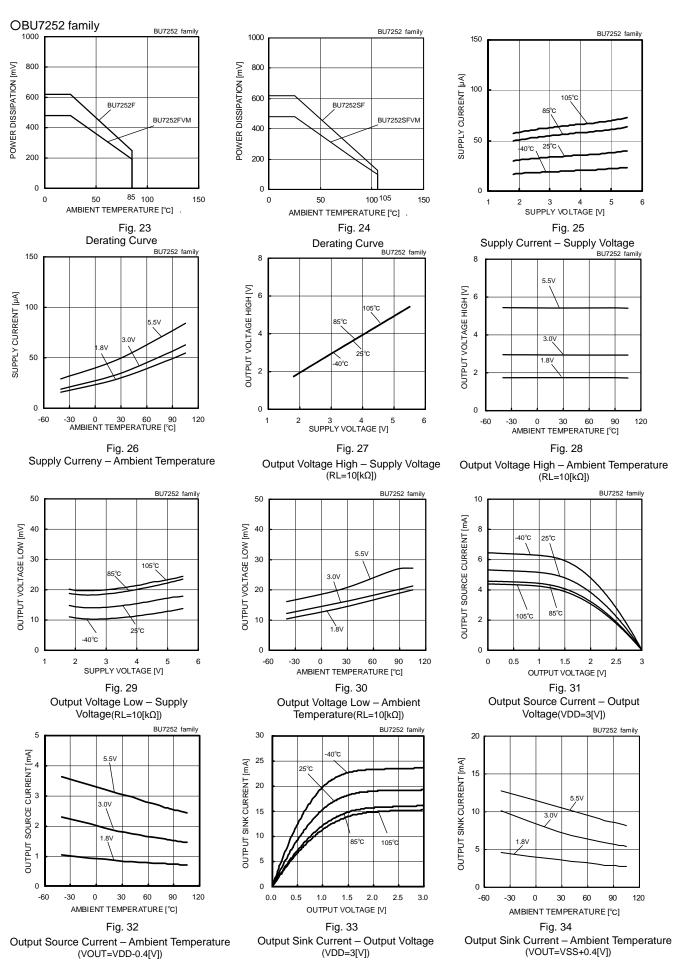
(*7) Full range,BU7232 : Ta=-40[°C] to +85[°C] BU7232S : Ta=-40[°C] to +105[°C]





Propagation Delay H-L – Ambient Temperature

(*) The above date is ability value of sample, it is not guaranteed. BU7251G : $-40[^{\circ}C]$ to $+85[^{\circ}C]$ BU7251SG : $-40[^{\circ}C]$ to $+105[^{\circ}C]$ to $+105[^{\circ}C]$



(*) The above date is ability value of sample, it is not guaranteed. BU7252 F/FVM : -40[°C] to+85[°C] BU7252S F/FVM : -40[°C] to+105[°C]

OBU7252 family

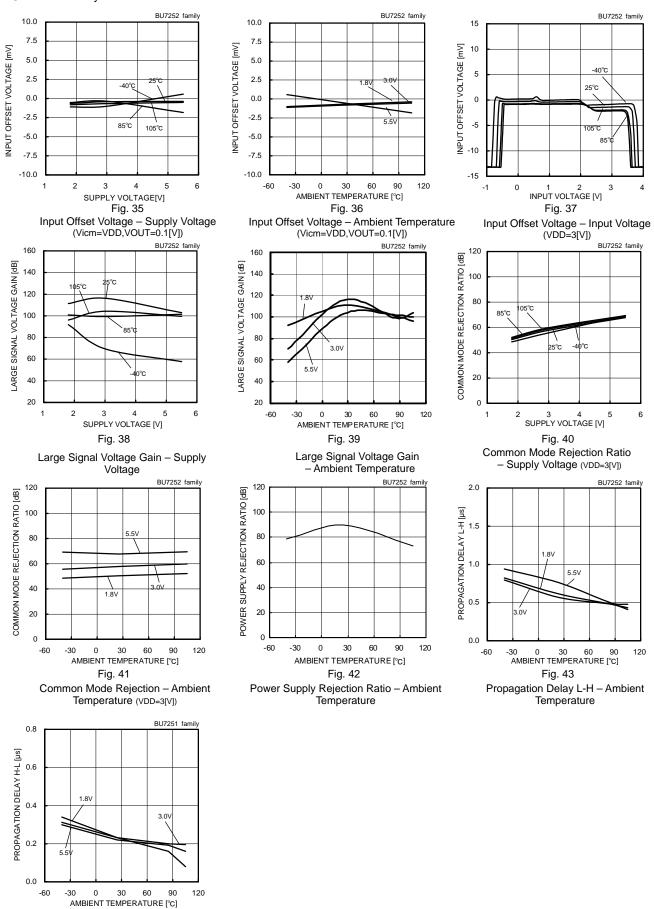
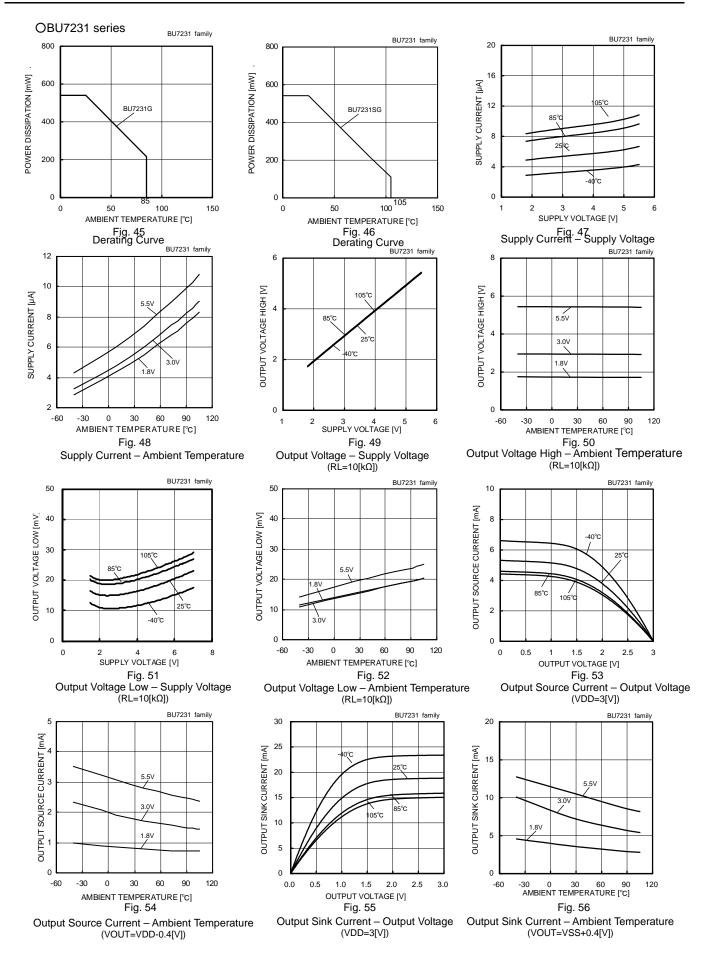


Fig. 44

Propagation Delay H-L – Ambient Temperature

(*) The above date is ability value of sample, it is not guaranteed. BU7252 F/FVM : -40[°C] to+85[°C] BU7252S F/FVM : -40[°C] to+105[°C]



(*) The above date is ability value of sample, it is not guaranteed. BU7231G : -40[°C] to+85[°C] BU7231SG : -40[°C] to+105[°C]

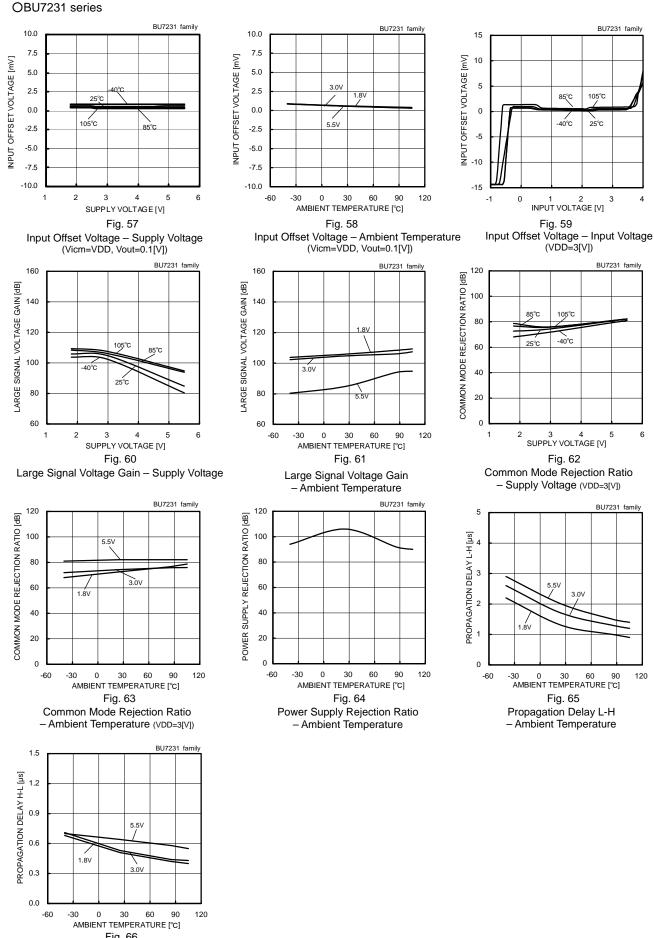
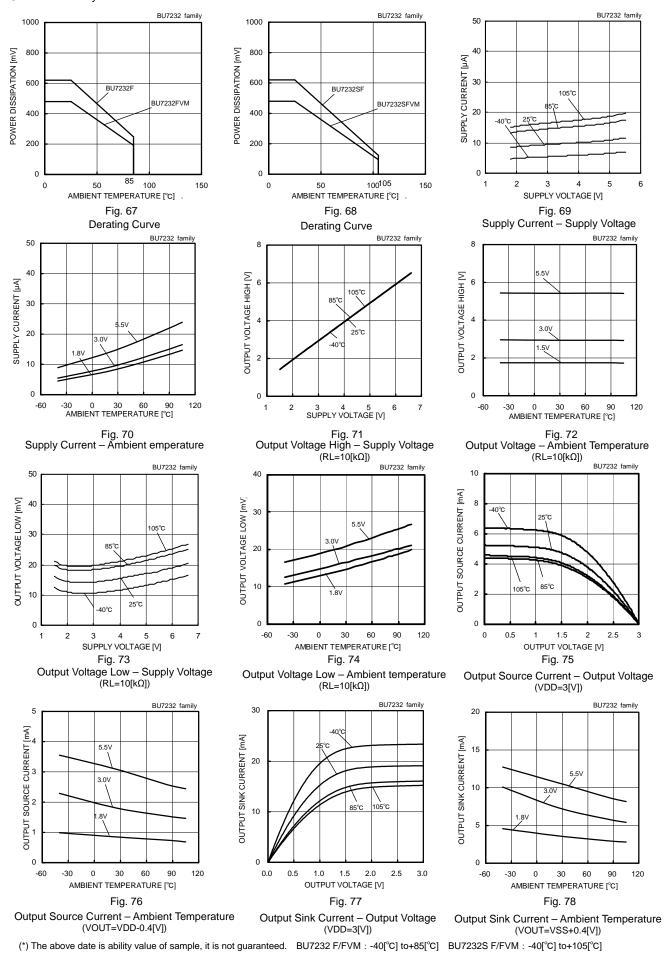
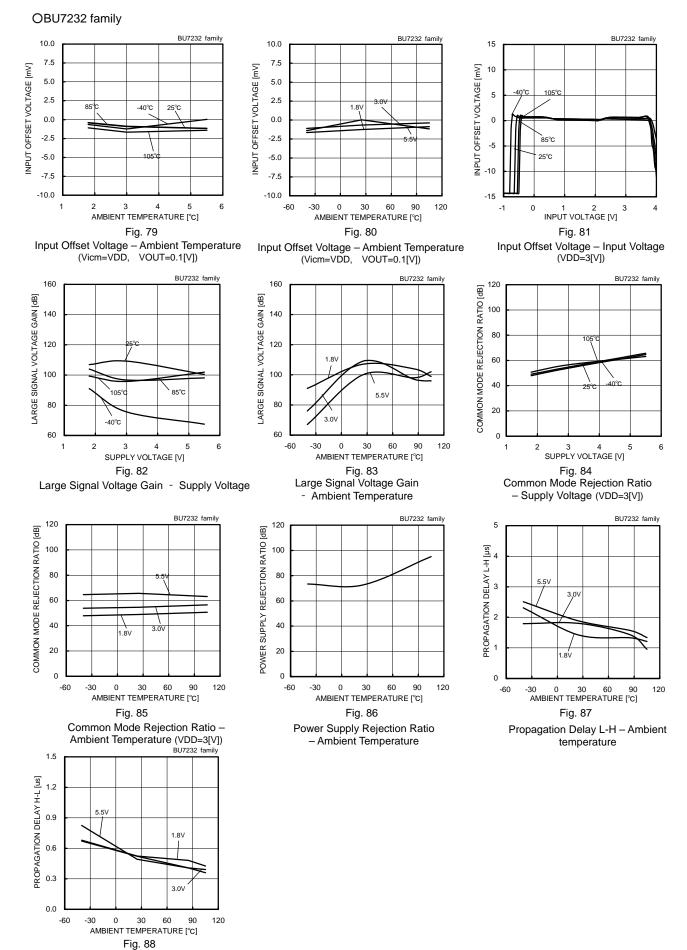


Fig. 66 Propagation Delay H-L– Ambient Temperature

(*) The above date is ability value of sample, it is not guaranteed. BU7231G : $-40[^{\circ}C]$ to $+85[^{\circ}C]$ BU7231SG : $-40[^{\circ}C]$ to $+105[^{\circ}C]$ to +105[

OBU7232 family

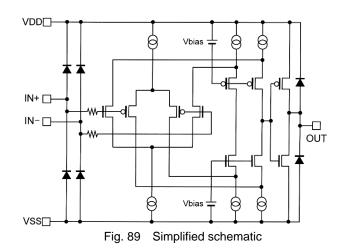




Propagation Delay H-L – Ambient Temperature

(*) The above date is ability value of sample, it is not guaranteed. BU7232 F/FVM : -40[°C] to+85[°C] BU7232S F/FVM : -40[°C] to+105[°C]

Schematic diagram



Test circuit1 NULL method

Deremeter	VF	61	60	S3					Calculation
Parameter	VF	51	S1 S2	33	VDD	VSS	EK	Vicm	Calculation
Input offset voltage	VF1	ON	ON	OFF	3	0	-0.1	0.3	1
	VF2		ON ON	ON	3	0	-0.3	0.3	2
Large signal voltage gain	VF3	ON					-2.7		
Common-mode rejection ratio	VF4		ON	OFF	3	0	-0.1	0	3
(Input common-mode voltage range)	VF5	ON						3	
Bower outputy rejection ratio	VF6			OFF	1.8	0	0.1	0.2	4
Power supply rejection ratio	VF7	ON	ON	UFF	5.5	0	-0.1	0.3	4

-Calculation-

1. Input offset Voltage (Vio)

$$Vio = \frac{|VF1|}{1 + Rf/Rs} [V]$$

2. Large signal voltage gain (Av)

Av = 20Log
$$\frac{2.4 \times (1 + Rf/Rs)}{1 \times F2}$$
 [dB]

3×(1+Rf/Rs) 3. Common-mode rejection ratio (CMRR) CMRR = 20Log [dB] VF4-VF5

4. Power supply rejection ratio (PSRR)

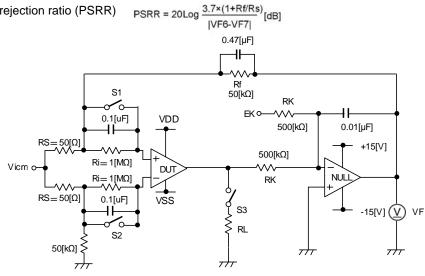


Fig. 90 Test Circuit 1 (one channel only)

•Test circuit2 switch condition

Unit		[V]
UTIT		IVI
U	•	

SW/No	SW							
SW No.	1	2	3	4	5	6	7	8
supply current	OFF	ON	ON	OFF	OFF	OFF	OFF	OFF
maximum output voltage RL=10 [kΩ]	OFF	ON	ON	ON	OFF	OFF	ON	OFF
output current	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF
response time	ON	OFF	ON	OFF	ON	OFF	OFF	ON

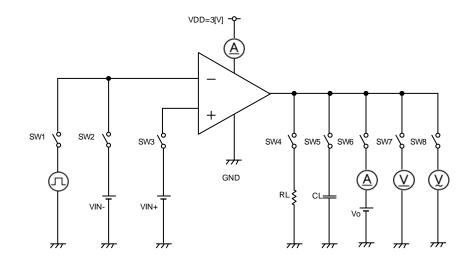


Fig. 91 Test circuit2 (one channel only)

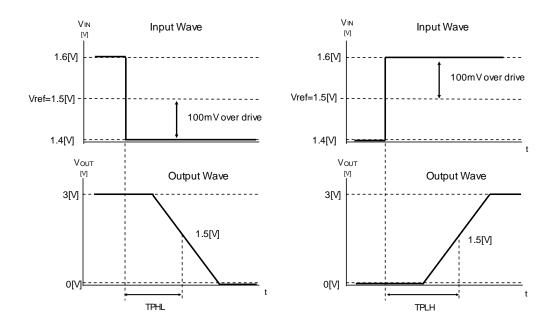


Fig. 92 Slew rate input output wave

• Description of electrical characteristics

Described here are the terms of electric characteristics used in this technical note. Items and symbols used are also shown. Note that item name and symbol and their meaning may differ from those on another manufacture's document or general document.

1. Absolute maximum ratings

Absolute maximum rating item indicates the condition which must not be exceeded. Application of voltage in excess of absolute Maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

1.1 Power supply voltage(VDD/VSS)

Indicates the maximum voltage that can be applied between the positive power supply terminal and negative power supply terminal without deterioration or destruction of characteristics of internal circuit.

1.2 Differential input voltage (Vid)

Indicates the maximum voltage that can be applied between non-inverting terminal and inverting terminal without deterioration and destruction of characteristics of IC.

1.3 Input common-mode voltage range (Vicm)

Indicates the maximum voltage that can be applied to non-inverting terminal and inverting terminal without deterioration or destruction of characteristics. Input common-mode voltage range of the maximum ratings not assure normal operation of IC. When normal operation of IC is desired, the input common-mode voltage of characteristics item must be followed.

1.4 Power dissipation (Pd)

Indicates the power that can be consumed by specified mounted board at the ambient temperature 25°C(normal temperature). As for package product, Pd is determined by the temperature that can be permitted by IC chip in the package(maximum junction temperature) and thermal resistance of the package

2. Electrical characteristics item

2.1 Input offset voltage (Vio)

Indicates the voltage difference between non-inverting terminal and inverting terminal.

- It can be translated into the input voltage difference required for setting the output voltage at 0 [V]
- 2.2 Input offset current (lio) Indicates the difference of input bias current between non-inverting terminal and inverting terminal.
- 2.3 Input bias current (lb)

Indicates the current that flows into or out of the input terminal. It is defined by the average of input bias current at non-inverting terminal and input bias current at inverting terminal.

- 2.4 Input common-mode voltage range (Vicm) Indicates the input voltage range where IC operates normally.
- 2.5 Large signal voltage gain (AV)

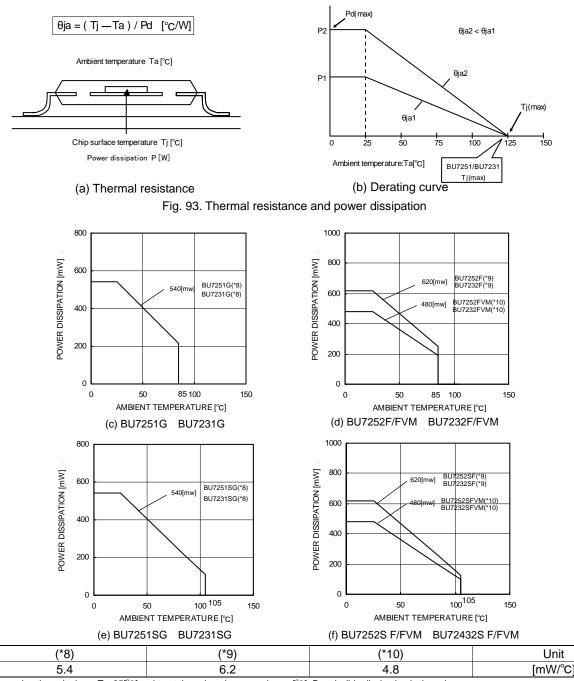
Indicates the amplifying rate (gain) of output voltage against the voltage difference between non-inverting terminal and inverting terminal. It is normally the amplifying rate (gain) with reference to DC voltage. Av = (Output voltage fluctuation) / (Input offset fluctuation)

- 2.6 Circuit current (ICC) Indicates the IC current that flows under specified conditions and no-load steady status.
- 2.7 Output sink current (OL) Indicates the maximum current that can be output under specified output condition (such as output voltage and load condition).
- 2.8 Output saturation voltage, Low level output voltage (VOL) Indicates the voltage range that can be output under specified load conditions.
- 2.9 Output leakage current, High level output current(I leak) Indicates the current that flows into IC under specified input and output conditions.
- 2.10 Response Time (Tre) The interval between the application of an input and output condition.
- 2.11 Common-mode rejection ratio (CMRR) Indicates the ratio of fluctuation of input offset voltage when in-phase input voltage is changed. It is normally the fluctuation of DC. CMRR =(Change of Input common-mode voltage)/(Input offset fluctuation)
- 2.12 Power supply rejection ratio (PSRR) Indicates the ratio of fluctuation of input offset voltage when supply voltage is changed. It is normally the fluctuation of DC. PSRR=(Change of power supply voltage)/(Input offset fluctuation)

Derating curve

Power dissipation (total loss) indicates the power that can be consumed by IC at Ta=25°C(normal temperature).IC is heated when it consumed power, and the temperature of IC ship becomes higher than ambient temperature. The temperature that can be accepted by IC chip depends on circuit configuration, manufacturing process, and consumable power is limited. Power dissipation is determined by the temperature allowed in IC chip (maximum junction temperature) and thermal resistance of package (heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage package (heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage temperature range. Heat generated by consumed power of IC radiates from the mold resin or lead frame of the package. The parameter which indicates this heat dissipation capability (hardness of heat release) is called thermal resistance. Fig.93 (a) shows the model of thermal resistance of the package. Thermal resistance θ a, ambient temperature Ta, junction temperature Tj, and power dissipation Pd can be calculated by the equation below :

θja = (Tj-Ta) / Pd [°C/W] · · · · (I)
Derating curve in Fig.93 (b) indicates power that can be consumed by IC with reference to ambient temperature. Power that
can be consumed by IC begins to attenuate at certain ambient temperature. This gradient is determined by thermal
resistance θja. Thermal resistance θja depends on chip size, power consumption, package, ambient temperature, package
condition, wind velocity, etc even when the same of package is used. Thermal reduction curve indicates a reference value
measured at a specified condition. Fig94(c)-(f) show a derating curve for an example of BU7251family, BU7252 family, BU7231
family, BU7232 family.



When using the unit above Ta=25[°C], subtract the value above per degree[°C]. Permissible dissipation is the value when FR4 glass epoxy board 70[mm]x70[mm]x1.6[mm] (cooper foil area below 3[%]) is mounted.

Fig. 94.

Notes for use

1) Absolute maximum ratings

Absolute maximum ratings are the values which indicate the limits, within which the given voltage range can be safely charged to the terminal. However, it does not guarantee the circuit operation.

2) Applied voltage to the input terminal

For normal circuit operation of voltage comparator, please input voltage for its input terminal within input common mode voltage VDD+0.3[V]. Then, regardless of power supply voltage, VSS-0.3[V] can be applied to inputterminals without deterioration or destruction of its characteristics.

- 3) Operating power supply (split power supply/single power supply) The voltage comparator operates if a given level of voltage is applied between VDD and VSS. Therefore, the operational amplifier can be operated under single power supply or split power supply.
- 4) Power dissipation (pd)

If the IC is used under excessive power dissipation. An increase in the chip temperature will cause deterioration of the radical characteristics of IC. For example, reduction of current capability. Take consideration of the effective power dissipation and thermal design with a sufficient margin. Pd is reference to the provided power dissipation curve.

5) Short circuits between pins and incorrect mounting

Short circuits between pins and incorrect mounting when mounting the IC on a printed circuits board, take notice of the direction and positioning of the IC.

If IC is mounted erroneously, It may be damaged. Also, when a foreign object is inserted between output, between output and VDD terminal or VSS terminal which causes short circuit, the IC may be damaged.

6) Using under strong electromagnetic field

Be careful when using the IC under strong electromagnetic field because it may malfunction.

7) Usage of IC

When stress is applied to the IC through warp of the printed circuit board, The characteristics may fluctuate due to the piezo effect. Be careful of the warp of the printed circuit board.

8) Testing IC on the set board

When testing IC on the set board, in cases where the capacitor is connected to the low impedance,make sure to discharge per fabrication because there is a possibility that IC may be damaged by stress. When removing IC from the set board, it is essential to cut supply voltage. As a countermeasure against the static electricity, observe proper grounding during fabrication process and take due care when carrying and storage it.

9) The IC destruction caused by capacitive load

The transistors in circuits may be damaged when VDD terminal and VSS terminal is shorted with the charged output terminal capacitor.

When IC is used as a operational amplifier or as an application circuit, where oscillation is not activated by an output capacitor, the output capacitor must be kept below $0.1[\mu F]$ in order to prevent the damage mentioned above.

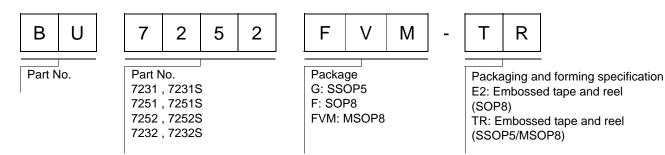
10) Decupling capacitor

Insert the deculing capacitance between VDD and VSS, for stable operation of operational amplifier.

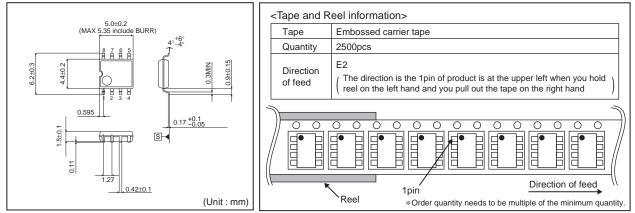
11) Latch up

Be careful of input vltage that exceed the VDD and VSS. When CMOS device have sometimes occur latch up operation. And protect the IC from abnormaly noise

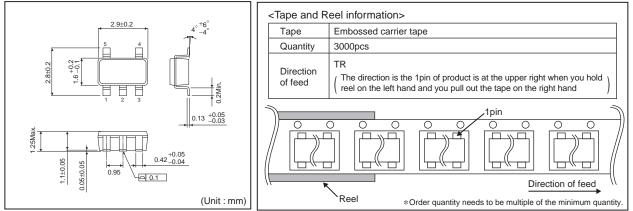
•Ordering part number

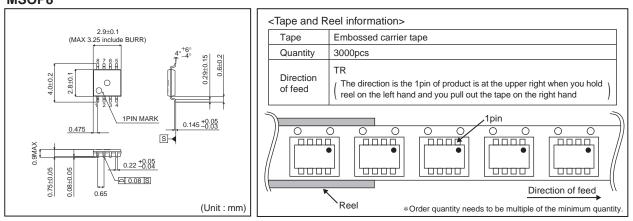


SOP8



SSOP5





MSOP8

Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA		
CLASSⅢ		CLASS II b			
CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSII		

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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